

30V N-Channel Enhancement Mode MOSFET**Description**

The PECN3402MR uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and high density cell Design for ultra low on-resistance. This device is suitable for use as a load switch or in PWM applications.

General Features

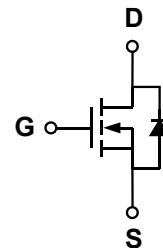
- ◆ $V_{DS} = 30V$, $I_D = 4A$
 $R_{DS(ON)}(\text{Typ.}) = 37.5\text{m}\Omega$ @ $V_{GS} = 10V$
 $R_{DS(ON)}(\text{Typ.}) = 40\text{m}\Omega$ @ $V_{GS} = 4.5V$
 $R_{DS(ON)}(\text{Typ.}) = 48\text{m}\Omega$ @ $V_{GS} = 2.5V$
- ◆ High power and current handing capability
- ◆ Lead free product is acquired
- ◆ Surface mount package

Application

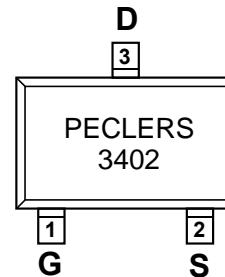
- ◆ PWM applications
- ◆ Load switch

Package

- ◆ SOT-23-3L

Schematic diagram**Marking and pin assignment**

SOT-23-3L
(TOP VIEW)



342— PECN3402MR
L— Package Information

**Ordering Information**

Part Number	Storage Temperature	Package	Devices Per Reel
PECN3402MR	-55°C to +150°C	SOT-23-3L	3000

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	V_{DS}	30	V
Gate-source voltage	V_{GS}	± 12	V
Continuous Drain Current	I_D	4	A
		3.2	A
Pulsed Drain Current	I_{DM}	16	A
Maximum power dissipation	P_D	1.4	W
		0.9	
Operating junction Temperature range	T_j	-55—150	°C

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF Characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	30	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =30V, V _{GS} =0V	-	-	1	μA
Gate-body leakage	I _{GSS}	V _{DS} =0V, V _{GS} =±12V	-	-	±100	nA
ON Characteristics						
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.5	0.75	1.5	V
Drain-source on-state resistance	R _{DS(ON)}	V _{GS} =10V, I _D =4A	-	37.5	45.0	mΩ
		V _{GS} =4.5V, I _D =3A		40.0	55.0	
		V _{GS} =2.5V, I _D =2A		48.0	65.0	
Forward transconductance	g _f	V _{GS} =5V, I _D =3.6A	-	14	-	S
Dynamic Characteristics						
IPECNut capacitance	C _{ISS}	V _{DS} =15V, V _{GS} =0V f=1.0MHz	-	235	-	pF
Output capacitance	C _{OSS}		-	35	-	
Reverse transfer capacitance	C _{RSS}		-	18	-	
Switching Characteristics						
Turn-on delay time	t _{D(ON)}	V _{DS} =15V V _{GS} =10V R _L =2.6 ohm R _{GEN} =3ohm	-	3.5	-	ns
Rise time	tr		-	1.5	-	
Turn-off delay time	t _{D(OFF)}		-	17.5	-	
Fall time	tf		-	2.5	-	
Total gate charge	Qg	V _{DS} =15V, I _D =4A V _{GS} =10V	-	10	-	nC
Gate-source charge	Qgs		-	0.95	-	
Gate-drain charge	Qgd		-	1.6	-	
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode forward voltage	V _{SD}	V _{GS} =0V, I _s =1A	-	0.82	1.16	V

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Maximum Junction-to-Ambient ^A	R _{θJA}	65	90	°C/W
Maximum Junction-to-Ambient ^A		85	125	
Maximum Junction-to-Lead ^B	R _{θJC}	63	80	

A: The value of R_{θJA} is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T A=25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

Typical Performance Characteristics

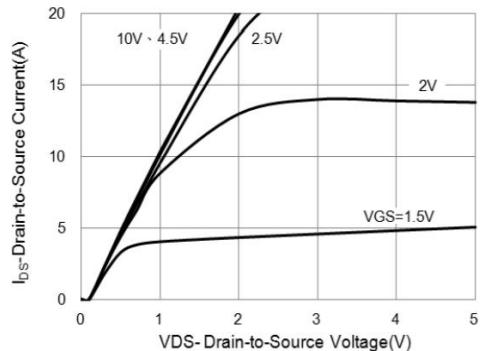


Fig 1: On-Region Characteristics

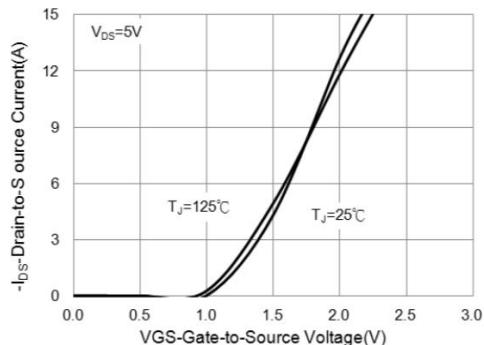


Figure 2: Transfer Characteristics

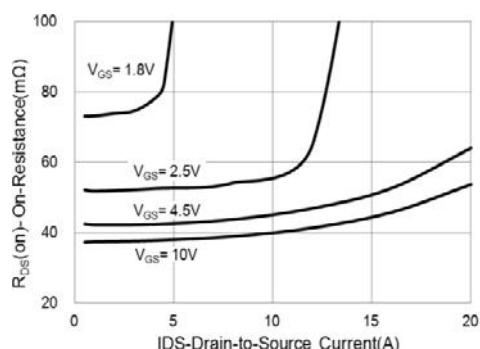


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

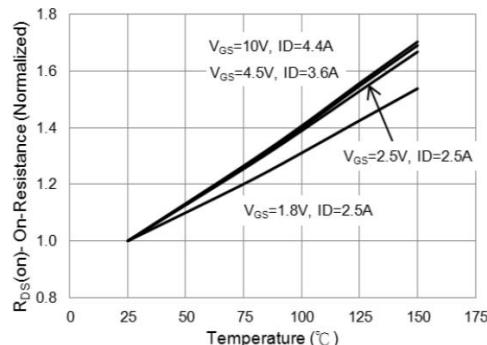


Figure 4: On-Resistance vs. Junction Temperature

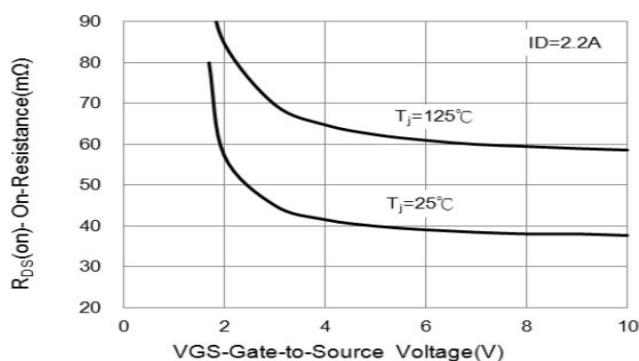


Figure 5: On-Resistance vs. Gate-Source Voltage

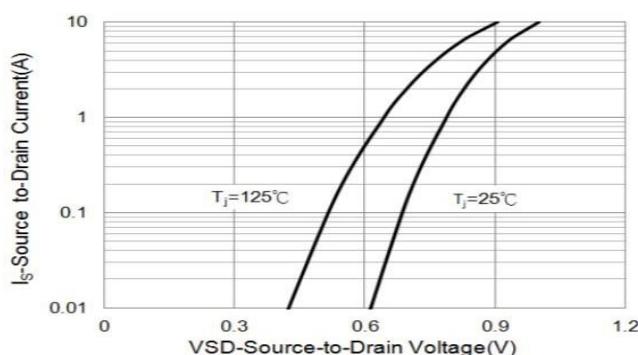


Figure 6: Body-Diode Characteristics

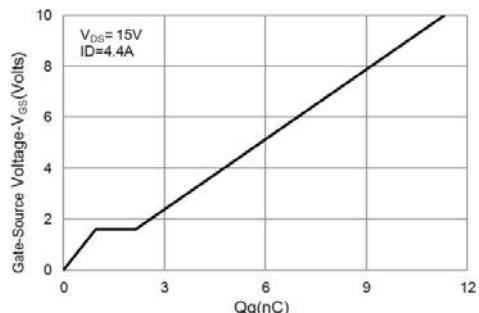


Figure 7:Gate-Charge Characteristics

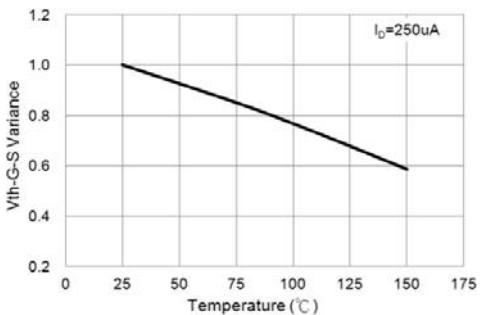
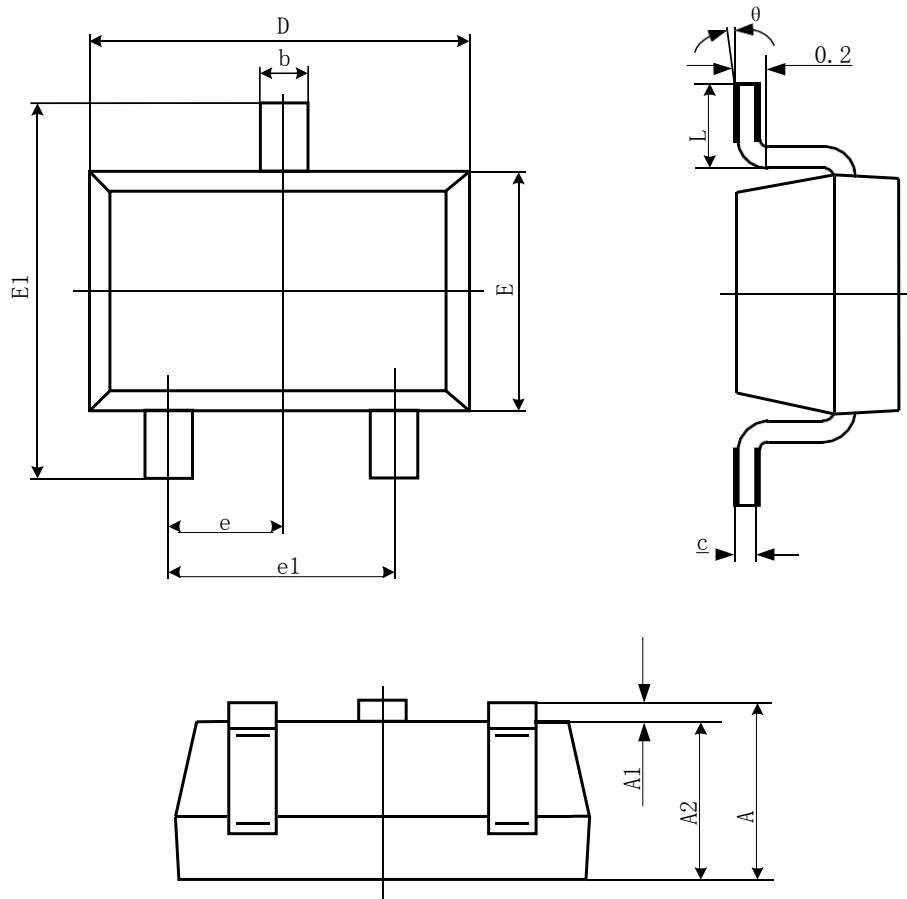


Figure 8:Threshold Voltage Variation with Temperature.

Package Information

- SOT-23-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°